

این دیتاشیت توسط توکل الکترونیک تهیه و ارائه شده است.
جهت مشاهده قیمت، موجودی و ثبت سفارش این قطعه به وبسایت توکل الکترونیک مراجعه فرمایید.



مشاهده قیمت و خرید

برای خرید و مشاهده سایر محصولات کلیک کنید



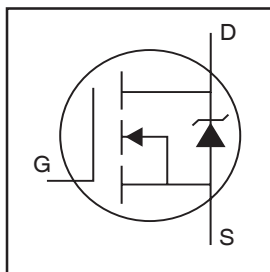
International IOR Rectifier

PD-94791B

IRF3205PbF

HEXFET® Power MOSFET

- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free



$$V_{DS} = 55V$$

$$R_{DS(on)} = 8.0m\Omega$$

$$I_D = 110A^{\circledast}$$

Description

Advanced HEXFET® Power MOSFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



TO-220AB

Absolute Maximum Ratings

	Parameter	Max.	Units
I_D @ $T_C = 25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	110 ^⑤	A
I_D @ $T_C = 100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	80	
I_{DM}	Pulsed Drain Current ^①	390	
P_D @ $T_C = 25^\circ C$	Power Dissipation	200	W
	Linear Derating Factor	1.3	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
I_{AR}	Avalanche Current ^①	62	A
E_{AR}	Repetitive Avalanche Energy ^①	20	mJ
dv/dt	Peak Diode Recovery dv/dt ^③	5.0	V/ns
T_J	Operating Junction and	-55 to + 175	°C
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Thermal Resistance

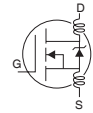
	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	0.75	°C/W
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50	—	
$R_{\theta JA}$	Junction-to-Ambient	—	62	

IRF3205PbF

International
IOR Rectifier

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	55	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.057	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = 1\text{mA}$
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	—	8.0	m Ω	$V_{GS} = 10V, I_D = 62A$ ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
g_{fs}	Forward Transconductance	44	—	—	S	$V_{DS} = 25V, I_D = 62A$ ④
I_{DSS}	Drain-to-Source Leakage Current	—	—	25	μA	$V_{DS} = 55V, V_{GS} = 0V$
		—	—	250		$V_{DS} = 44V, V_{GS} = 0V, T_J = 150^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -20V$
Q_g	Total Gate Charge	—	—	146	nC	$I_D = 62A$
Q_{gs}	Gate-to-Source Charge	—	—	35		$V_{DS} = 44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge	—	—	54		$V_{GS} = 10V$, See Fig. 6 and 13
$t_{d(on)}$	Turn-On Delay Time	—	14	—	ns	$V_{DD} = 28V$
t_r	Rise Time	—	101	—		$I_D = 62A$
$t_{d(off)}$	Turn-Off Delay Time	—	50	—		$R_G = 4.5\Omega$
t_f	Fall Time	—	65	—		$V_{GS} = 10V$, See Fig. 10 ④
L_D	Internal Drain Inductance	—	4.5	—	nH	Between lead, 6mm (0.25in.) from package and center of die contact
L_S	Internal Source Inductance	—	7.5	—		
C_{iss}	Input Capacitance	—	3247	—	pF	$V_{GS} = 0V$
C_{oss}	Output Capacitance	—	781	—		$V_{DS} = 25V$
C_{rss}	Reverse Transfer Capacitance	—	211	—		$f = 1.0\text{MHz}$, See Fig. 5
E_{AS}	Single Pulse Avalanche Energy ②	—	1050 ⑥	264 ⑦	mJ	$I_{AS} = 62A, L = 138\mu H$



Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)	—	—	110	A	MOSFET symbol showing the integral reverse p-n junction diode.
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	390		
V_{SD}	Diode Forward Voltage	—	—	1.3	V	$T_J = 25^\circ\text{C}, I_S = 62A, V_{GS} = 0V$ ④
t_{rr}	Reverse Recovery Time	—	69	104	ns	$T_J = 25^\circ\text{C}, I_F = 62A$
Q_{rr}	Reverse Recovery Charge	—	143	215	nC	$di/dt = 100A/\mu s$ ④
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$)				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- ② Starting $T_J = 25^\circ\text{C}, L = 138\mu H$
 $R_G = 25\Omega, I_{AS} = 62A$. (See Figure 12)
- ③ $I_{SD} \leq 62A, di/dt \leq 207A/\mu s, V_{DD} \leq V_{(BR)DSS}, T_J \leq 175^\circ\text{C}$
- ④ Pulse width $\leq 400\mu s$; duty cycle $\leq 2\%$.
- ⑤ Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.
- ⑥ This is a typical value at device destruction and represents operation outside rated limits.
- ⑦ This is a calculated value limited to $T_J = 175^\circ\text{C}$.

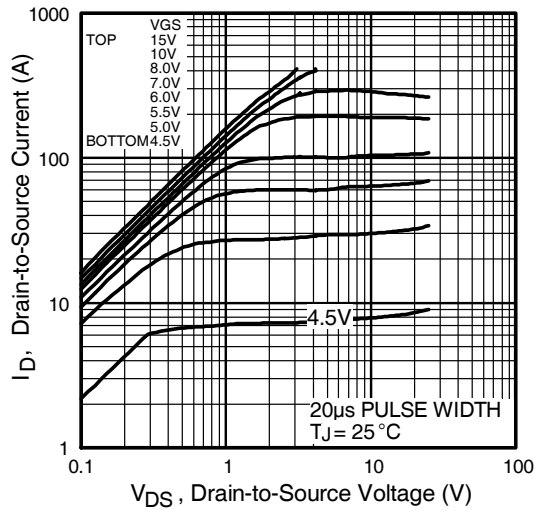


Fig 1. Typical Output Characteristics

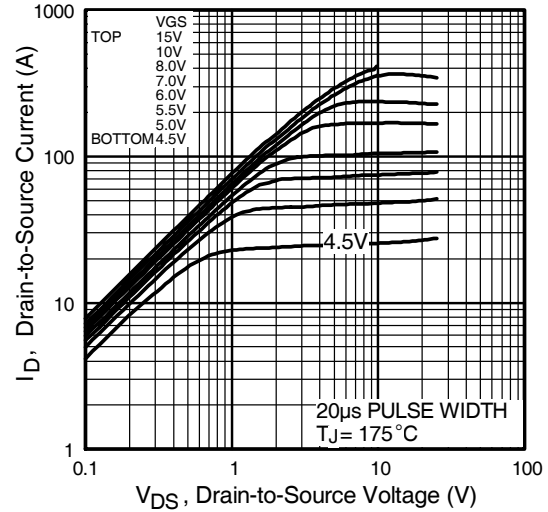


Fig 2. Typical Output Characteristics

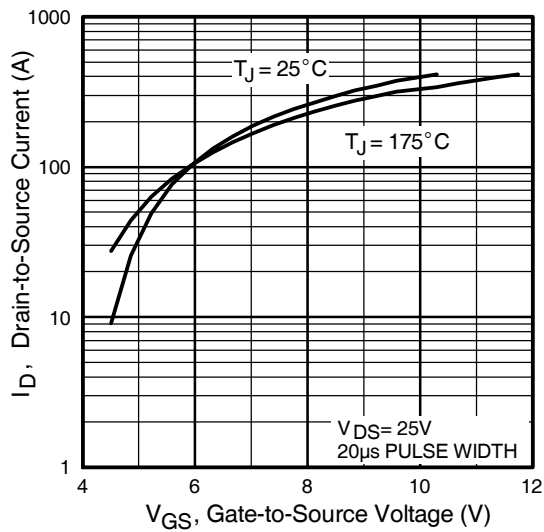


Fig 3. Typical Transfer Characteristics

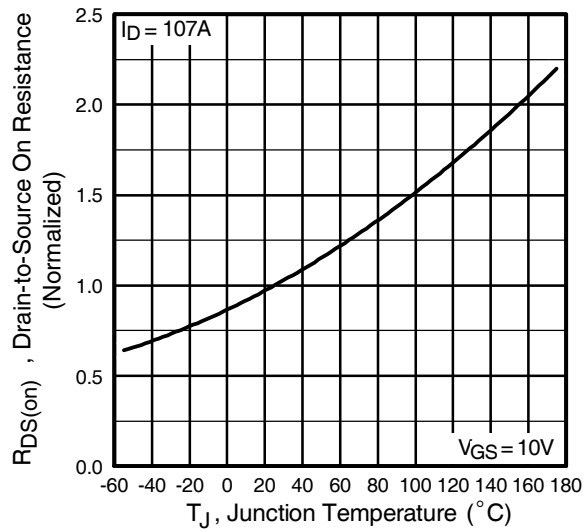
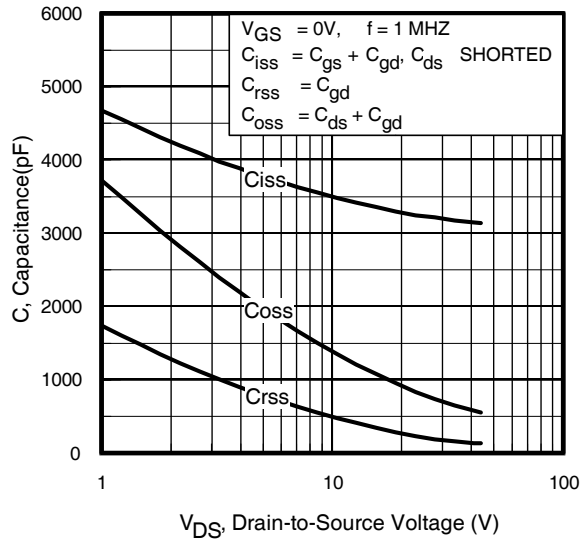
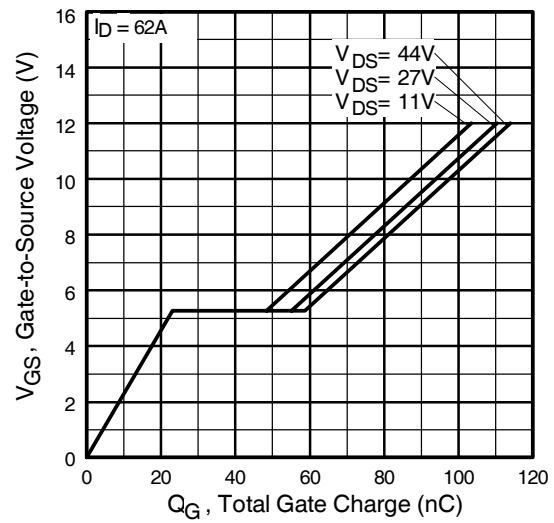
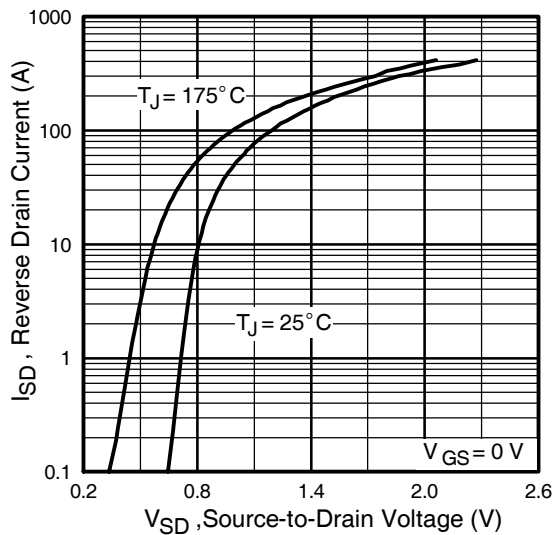
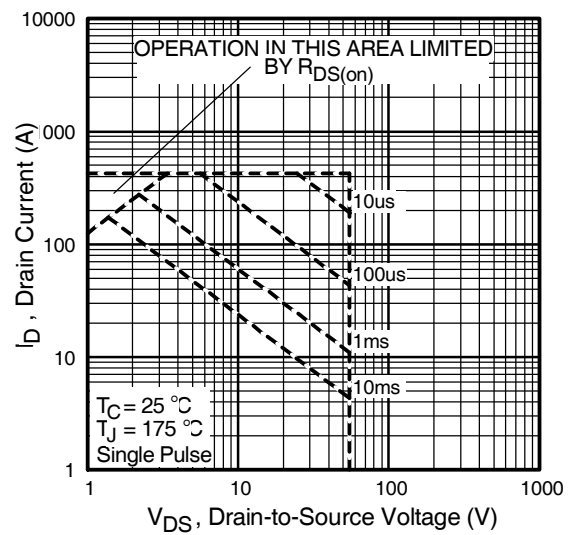


Fig 4. Normalized On-Resistance Vs. Temperature

IRF3205PbF

International
IR Rectifier



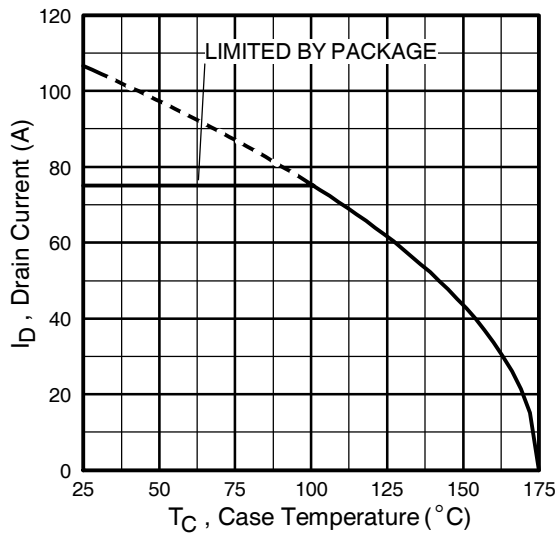


Fig 9. Maximum Drain Current Vs. Case Temperature

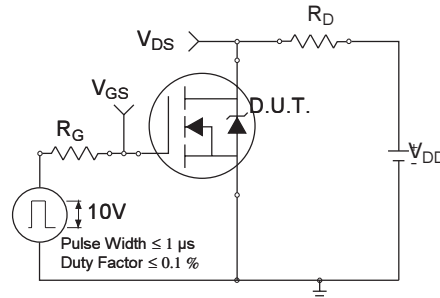


Fig 10a. Switching Time Test Circuit

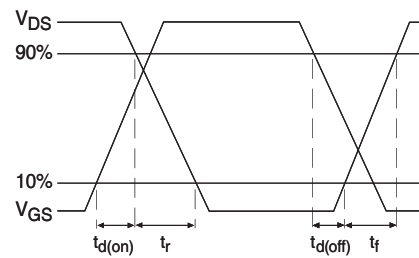


Fig 10b. Switching Time Waveforms

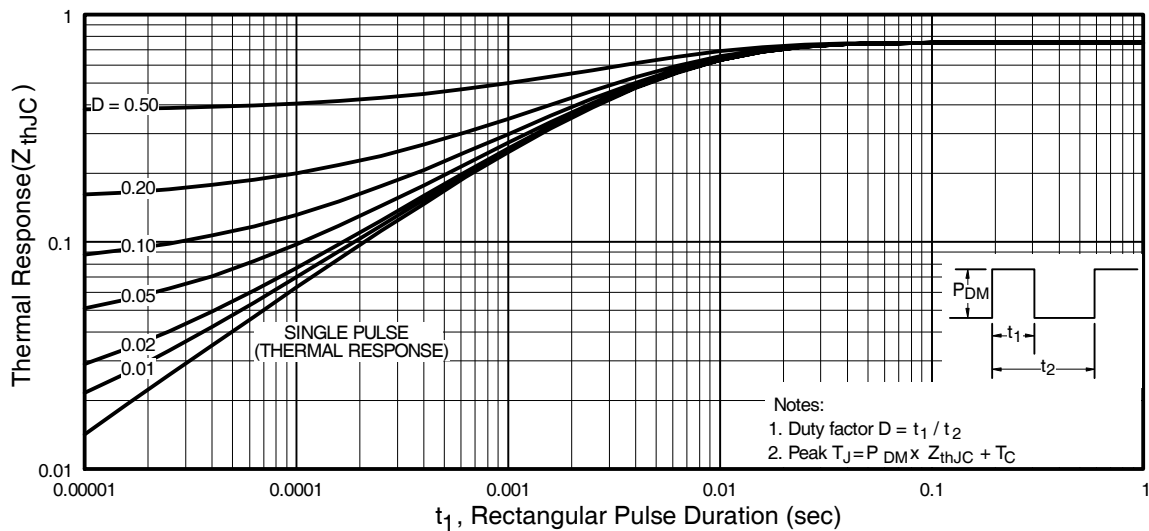


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

IRF3205PbF

International
IR Rectifier

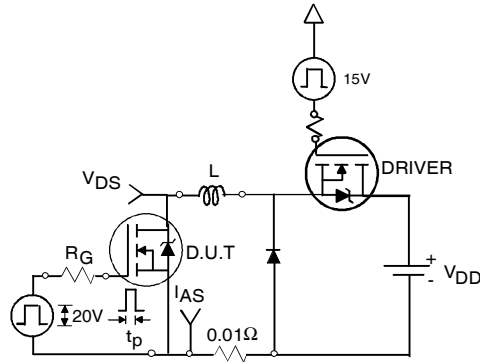


Fig 12a. Unclamped Inductive Test Circuit

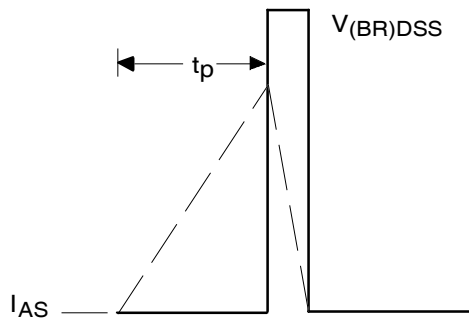


Fig 12b. Unclamped Inductive Waveforms

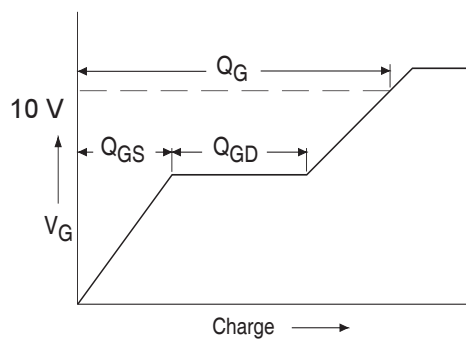


Fig 13a. Basic Gate Charge Waveform

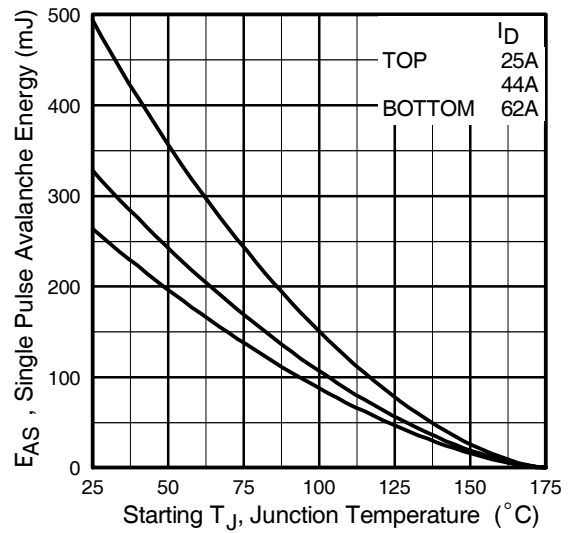


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

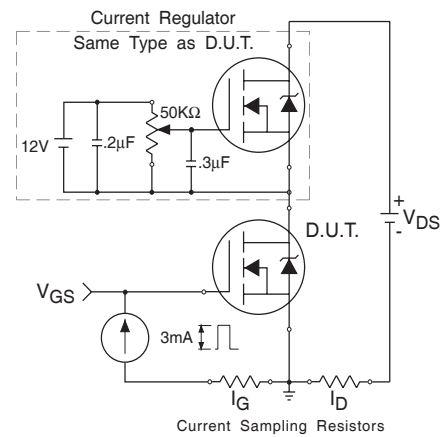


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit

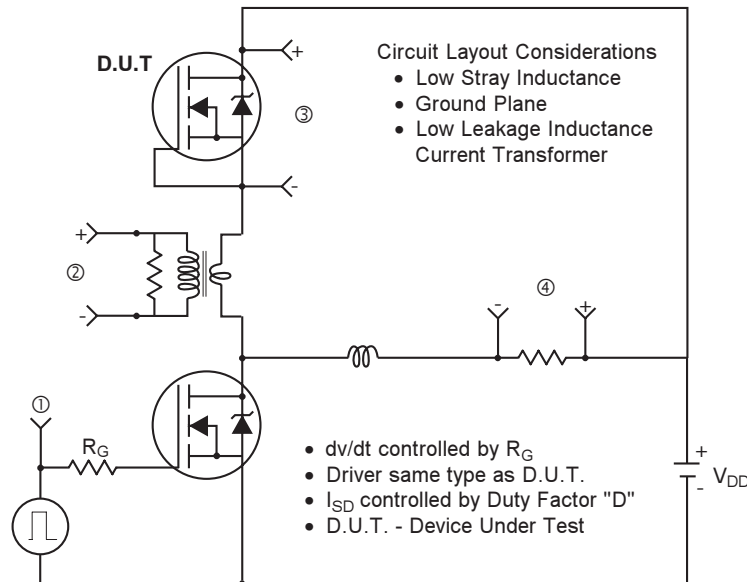
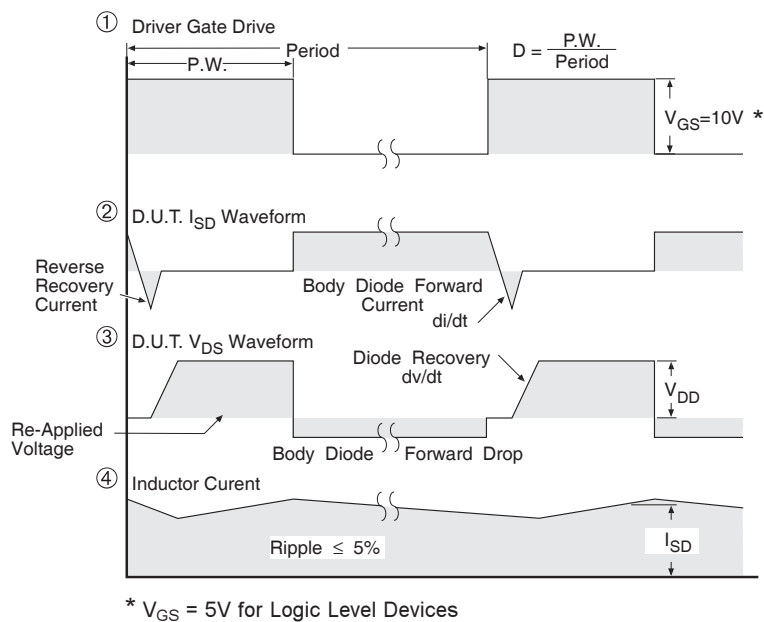
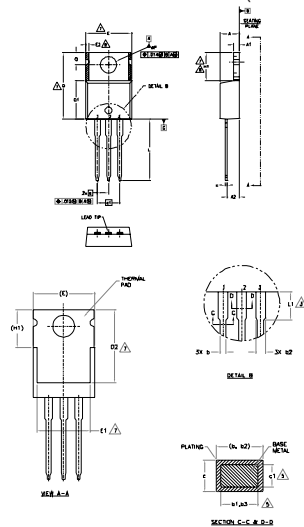


Fig 14. For N-Channel HEXFETS

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



- NOTES:
- 1- DIMENSIONING AND TOLERANCING ARE PER ASME Y14.5 M - 1994
 - 2- DIMENSIONS ARE SHOWN IN INCHES (MILLIMETERS)
 - 3- LEAD DIMENSION AND FINISH DIMENSIONING IN U.S.
 - 4- DIMENSION D, D1 & E DO NOT INCLUDE WELD FILL. WELD FILL SHALL NOT EXCEED 0.015" PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY
 - 5- DIMENSION M, N & A1 APPLY TO BASE METAL ONLY.
 - 6- CONTROLLING DIMENSION : FINISH.
 - 7- THERMAL PAD CONTROL OPTION: BOTH DIMENSIONS L1, L2 & L1
 - 8- DIMENSION L2 X H1 DEFINE A ZONE WHERE STRAPPING AND SINGULATING IRREGULARITIES ARE ACCEPTED.
 - 9- OUTLINE CONFORMS TO JEDEC J-220, EXCEPT A1 (max.) AND D2 (min.)

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	WFL	THICK	WFL	THICK	
A1	0.51	1.45	0.02	0.058	
A2	2.03	2.92	0.08	0.115	
B1	0.38	1.01	0.015	0.039	
B2	0.38	0.97	0.015	0.038	5
C1	1.14	1.78	0.045	0.070	
C2	1.14	1.73	0.045	0.069	
D1	0.36	0.81	0.014	0.024	
D2	0.36	0.86	0.014	0.024	
E1	0.32	0.55	0.013	0.014	4
E2	0.36	0.62	0.015	0.020	
F1	11.68	12.88	0.460	0.507	
F2	11.50	12.67	0.453	0.500	7
G1	6.86	8.69	0.270	0.340	
G2	-	0.76	-	0.030	8
	2.54 (100)		0.1 (4)		
H	3.84	6.86	0.220	0.270	7,8
I1	12.70	14.73	0.500	0.580	
I2	3.56	4.06	0.140	0.160	5
J1	3.54	4.06	0.139	0.161	
J2	3.54	4.06	0.139	0.161	
K	5.44	3.42	0.200	0.135	

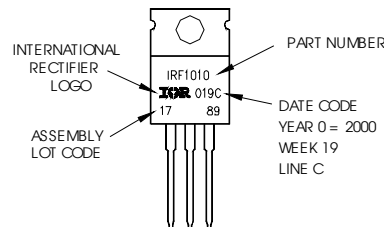
L10 Assignment

- ITEMS**
1- GATE
2- DRUM
3- SOURCE
- FIELD OFFICE**
1- GATE
2- COLLECT
3- WATER
- DOCS**
1- ALICE
2- CAROL
3- ALICE

TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010
LOT CODE 1789
ASSEMBLED ON WW 19, 2000
IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead - Free"



TO-220AB package is not recommended for Surface Mount Application

Notes:

1. For an Automotive Qualified version of this part please see <http://www.irf.com/product-info/auto/>
2. For the most current drawing please refer to IRF website at <http://www.irf.com/package/>

Data and specifications subject to change without notice.
This product has been designed and qualified for the Industrial market.
Qualification Standards can be found on IR's Web site.

International
IOR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.07/2010